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(12) **United States Design Patent**
Forster

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(54) **RFID INLAY**

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(**) Term: **15 Years**

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(52) **U.S. Cl.**
USPC **D14/230**

(58) **Field of Classification Search**
USPC D14/230–238, 203.6, 204, 216, 221,
D14/238.1, 240, 242, 299, 343, 358, 509;
D13/182
CPC H01Q 7/00; H01Q 13/10; H01Q 9/285;
H01Q 19/30; H01Q 19/12; H01Q 1/36;
H01Q 1/38; H01Q 1/0475; H01Q 1/034;
H05K 11/00; G05D 1/0234; G06K
19/07749

See application file for complete search history.

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Primary Examiner — John Windmuller

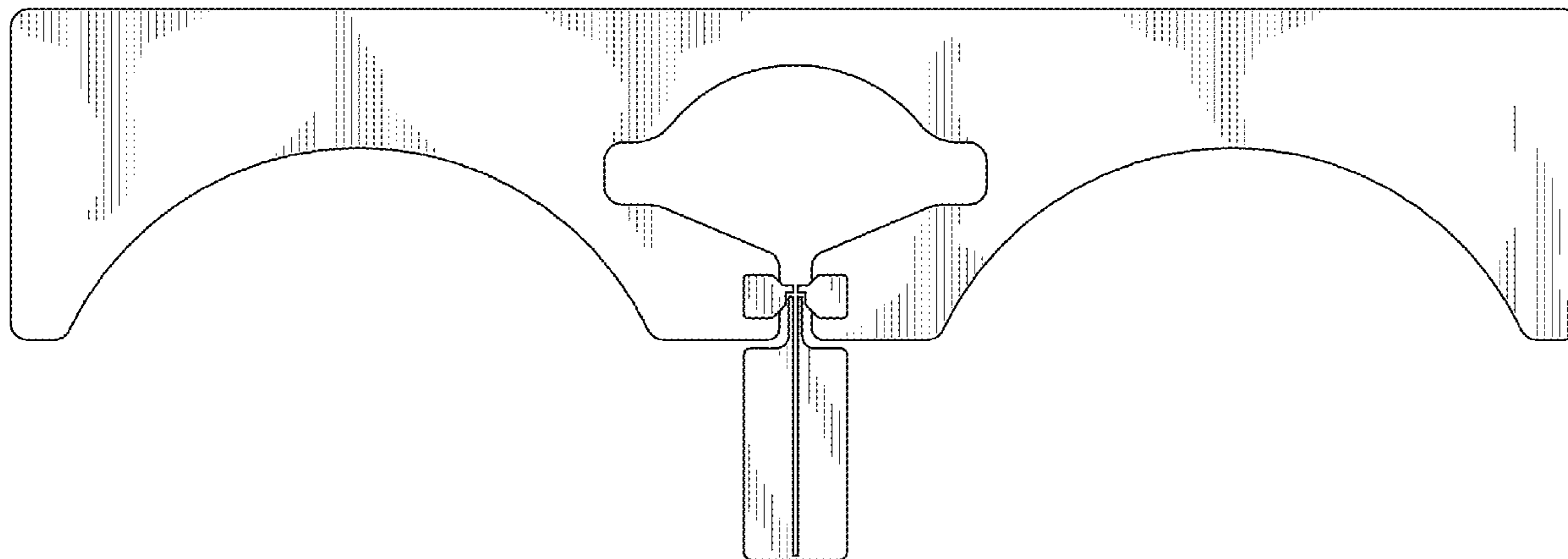
(57) **CLAIM**

The ornamental design for an RFID inlay, as shown and described.

DESCRIPTION

FIG. 1 is an isometric view of an RFID inlay, showing my design; and,
FIG. 2 is a top view thereof.

1 Claim, 2 Drawing Sheets



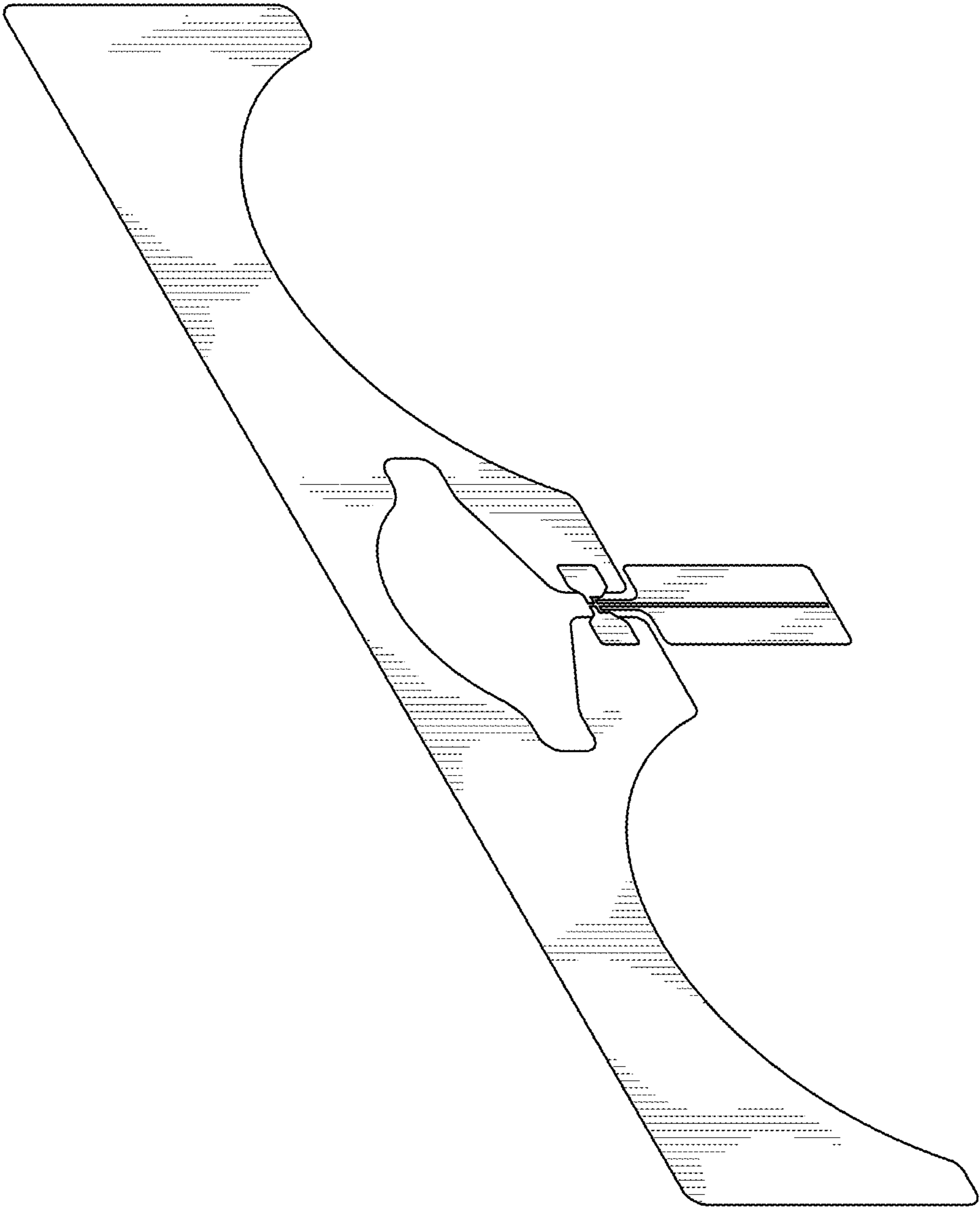


FIG. 1

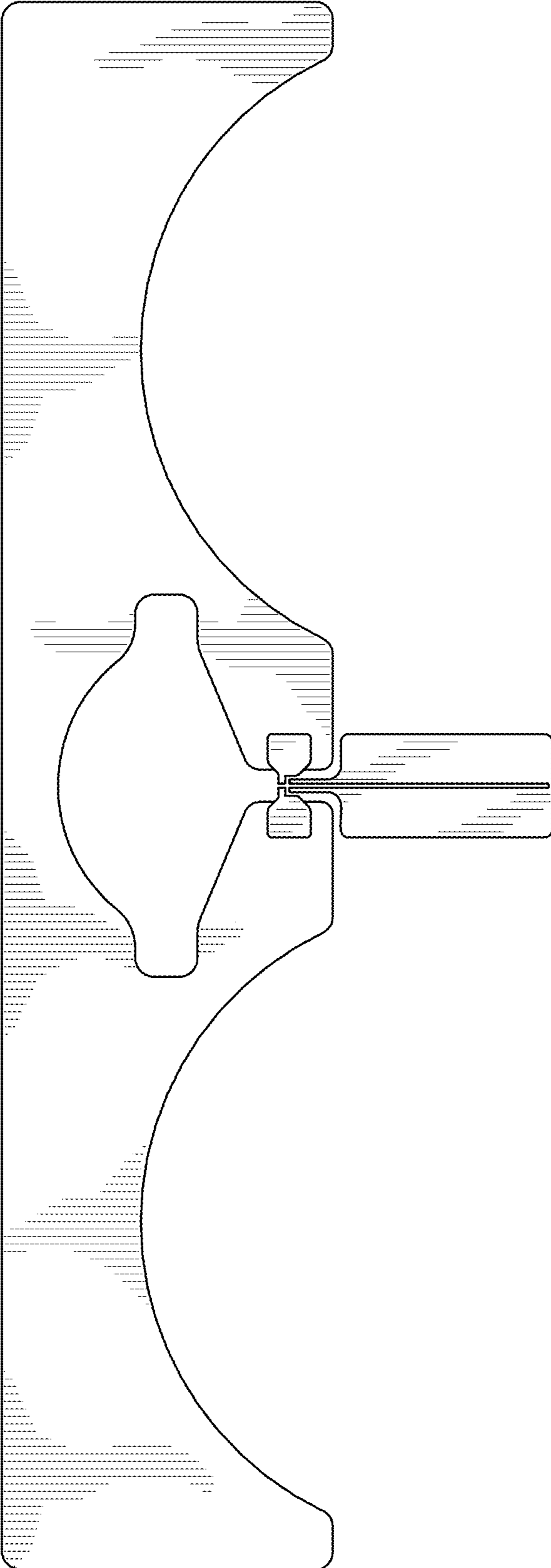


FIG. 2